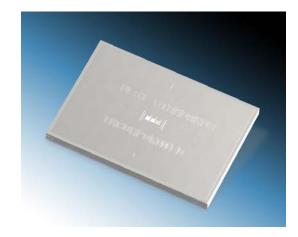
DIMENSIONAL

VL ∕ I Standards

Surface Topography Standards

STAY ON TOP OF 3D PROBE CALIBRATION. The Surface Topography Standard (STS) uses a combination of step height and pitch to enable three-dimensional calibration of optical interferometric microscopes and AFMs. Multiple pitch gratings take calibration further, allowing characterization of scan linearity. On high resolution tools such as the Atomic Force Microscope, traceability to SI units through NIST calibration can be achieved, driving your equipment to its full potential.

The Surface Topography
Standard, shown at right,
consists of an etched silicon
dioxide "waffle pattern" on a
silicon substrate.



PRODUCT DESCRIPTION

The Surface Topography Standard consists of a 12 mm x 8 mm silicon die with a pitch cluster patterned in a layer of silicon dioxide. The pitch cluster contains three distinct grid patterns. Each grid pattern measures approximately 270 µm x 270 µm and consists of an array of alternating bars and spaces with an extremely uniform pitch in both the X and Y direction. Two models are available: the STS2 has pitches of 1.8 µm, 3 µm, and 5 µm; the STS3 has pitches of 3 μm, 10 μm, and 20 μm. Each model is available with vertical step heights of either 18 nm, 44 nm, 100 nm or 180 nm. Our precise manufacturing technique ensures a very regular topographic pattern, allowing accurate measurement across the entire working area of the standard.

PRODUCT SPECIFICATIONS

- Dimensions
 12 mm x 8 mm silicon die
- Materials
 Silicon Dioxide on Silicon coated with
 Platinum (except STS2-1000S & STS2-1800S models)
- Nominal Pitch Values (X and Y)
 STS2: 1.8 μm, 3 μm, and 5 μm (all on one standard)

STS3: 3 μm , 10 μm , and 20 μm (all on one standard)

- Nominal Height Values (Z)
 18 nm, 44 nm, 100 nm, 180 nm
- Traceability
 Traceable to SI units through NIST